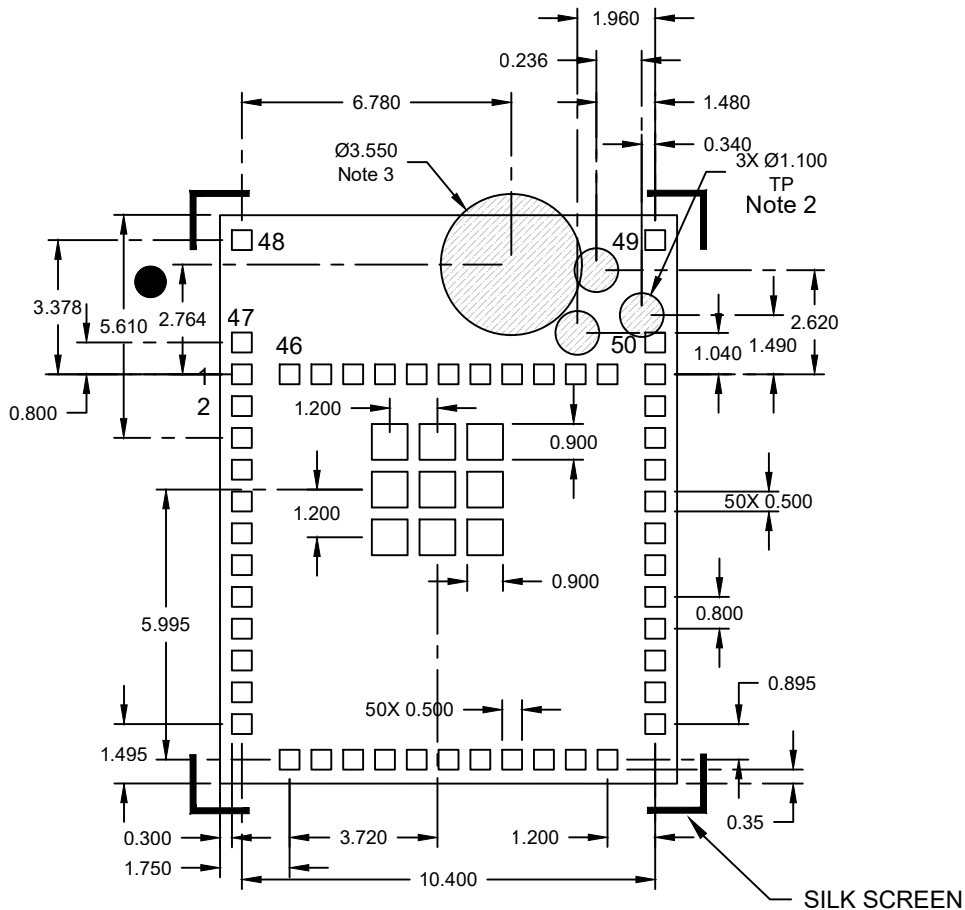



50-Lead Printed Circuit Board Module (9MW) 11.5x14.3x2.6mm [MODULE]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

 Copper Keep-Out Area for Test Point

Notes:

1. All dimensions are in millimeters.
2. Keep this area free from all metal, including ground fill.
3. Keep these areas free from routes and exposed copper. Ground fill with solder mask may be placed here.